

## SCOPE :

This specification applies to the Pb Free high current type SMD inductors  
for MSCD-73-SERIES

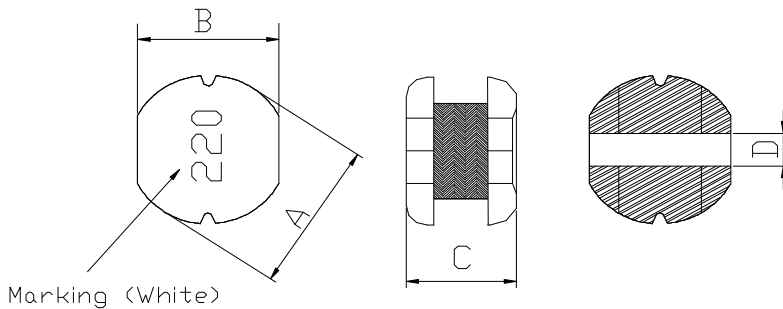
## PRODUCT IDENTIFICATION

MSCD - 73 - 220 M-RU

① ② ③ ④

- ① Product Code
- ② Dimensions Code
- ③ Inductance Code
- ④ Tolerance Code

## (1) SHAPES AND DIMENSIONS



A: $7.8 \pm 0.3$	mm
B: $7.2 \pm 0.3$	mm
C: 4.0 Max.	mm
D: 2.6 Typ.	mm

## (2) ELECTRICAL SPECIFICATIONS

### SEE TABLE 1

#### TEST INSTRUMENTS

- L : HP 4284A PRECISION LCR METER (or equivalent)
- RDC : CHROMA MODEL 16502 MILLIOHMETER (or equivalent)

## (3) CHARACTERISTICS

- (3)-1 Ambient temperature .....  $+60^{\circ}\text{C}$  Max.
- (3)-2 Operate temperature range .....  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$   
(Including self temp. rise)
- (3)-3 Storage temperature range .....  $-40^{\circ}\text{C} \sim +125^{\circ}\text{C}$



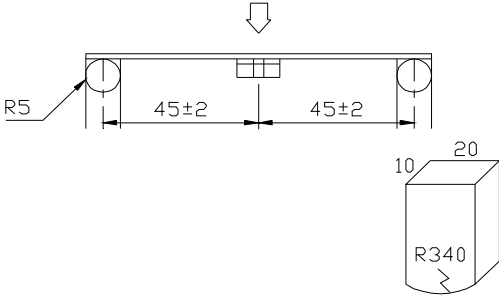
**TABLE 1**

MAGLAYERS PT/NO.	Inductance L( $\mu$ H)	Percent Tolerance	Test Frequency	Resistance RDC( $\Omega$ )Max.	Rated DC Current IDC(A)	Marking
MSCD-73-1R0□-RU	1.0	M,N	100kHz/0.25V	10.0m	4.60	1R0
MSCD-73-3R3□-RU	3.3	M,N	100kHz/0.25V	20.0m	4.00	3R3
MSCD-73-4R7□-RU	4.7	M,N	100kHz/0.25V	23.4m	3.70	4R7
MSCD-73-6R8□-RU	6.8	M,N	100kHz/0.25V	36.0m	3.00	6R8
MSCD-73-100□-RU	10	M,N	100kHz/0.25V	80.3m	1.44	100
MSCD-73-120□-RU	12	M,N	100kHz/0.25V	89.7m	1.39	120
MSCD-73-150□-RU	15	M,N	100kHz/0.25V	0.104	1.24	150
MSCD-73-180□-RU	18	M,N	100kHz/0.25V	0.111	1.12	180
MSCD-73-220□-RU	22	M,N	100kHz/0.25V	0.129	1.07	220
MSCD-73-270□-RU	27	M,N	100kHz/0.25V	0.153	0.94	270
MSCD-73-330□-RU	33	M,N	100kHz/0.25V	0.170	0.85	330
MSCD-73-390□-RU	39	M,N	100kHz/0.25V	0.217	0.74	390
MSCD-73-470□-RU	47	M,N	100kHz/0.25V	0.252	0.68	470
MSCD-73-560□-RU	56	K,M	100kHz/0.25V	0.282	0.64	560
MSCD-73-680□-RU	68	K,M	100kHz/0.25V	0.332	0.59	680
MSCD-73-820□-RU	82	K,M	100kHz/0.25V	0.406	0.54	820
MSCD-73-101□-RU	100	K,M	100kHz/0.25V	0.481	0.51	101
MSCD-73-121□-RU	120	K,M	100kHz/0.25V	0.536	0.49	121
MSCD-73-151□-RU	150	K,M	100kHz/0.25V	0.755	0.40	151
MSCD-73-181□-RU	180	K,M	100kHz/0.25V	1.022	0.36	181
MSCD-73-221□-RU	220	K,M	100kHz/0.25V	1.200	0.31	221
MSCD-73-271□-RU	270	K,M	100kHz/0.25V	1.306	0.29	271
MSCD-73-331□-RU	330	K,M	100kHz/0.25V	1.495	0.28	331
MSCD-73-391□-RU	390	K,M	100kHz/0.25V	2.70	0.27	391
MSCD-73-471□-RU	470	K,M	100kHz/0.25V	3.00	0.25	471

※ □ Specify the inductance tolerance, K( $\pm$ 10%),M( $\pm$ 20%),N( $\pm$ 30%)

※ IDC : Based on inductance change ( $\Delta$ L/Lo : drop 10% Max.) @ ambient temperature 25°C  
and Based on temperature rise ( $\Delta$ T : 40°C TYP.)

**(4) RELIABILITY TEST METHOD  
MECHANICAL**

TEST ITEM	SPECIFICATION	TEST DETAILS
Substrate bending	$\Delta L/L_0 \leq \pm 5\%$  There shall be no mechanical damage or electrical damage.	<p>The sample shall be soldered onto the printed circuit board in figure 1 and a load applied until the figure in the arrow direction is made approximately 3mm.(keep time 30 seconds)</p> <p>PCB dimension shall the page 7/9</p> <p>F(Pressurization)</p>  <p>PRESSURE ROD figure-1</p>
Vibration	$\Delta L/L_0 \leq \pm 5\%$  There shall be no mechanical damage.	<p>The sample shall be soldered onto the printed circuit board and when a vibration having an amplitude of 1.52mm and a frequency of from 10 to 55Hz/1 minute repeated should be applied to the 3 directions (X,Y,Z) for 2 hours each. (A total of 6 hours)</p>
Solderability	New solder More than 90%	<p>Flux (rosin, isopropyl alcohol{JIS-K-1522}) shall be coated over the whole of the sample before hard, the sample shall then be preheated for about 2 minutes in a temperature of 130~150°C and after it has been immersed to a depth 0.5mm below for 3±0.2 seconds fully in molten solder M705 with a temperature of 245±5°C.</p> <p>More than 90% of the electrode sections shall be covered with new solder smoothly when the sample is taken out of the solder bath.</p>

## MECHANICAL

TEST ITEM	SPECIFICATION	
Resistance to Soldering heat (reflow soldering)	There shall be no damage or problems.	<p style="text-align: center;"><b>Temperature profile of reflow soldering</b></p> <p>The graph shows the temperature profile for reflow soldering. The y-axis is 'Soldering temperature (°C)' ranging from 50 to 300. The x-axis represents time. The profile starts with a 2-minute pre-heating phase at 150 ~ 180°C. This is followed by a 10-second soldering phase where the temperature reaches a peak of 260±3°C. A 30-second minimum dwell is maintained at 230°C. The final phase is slow cooling, where the specimen is stored at room temperature for 2 minutes or more.</p> <p>The specimen shall be passed through the reflow oven with the condition shown in the above profile for 1 time.</p> <p>The specimen shall be stored at standard atmospheric conditions for 1 hour, after which the measurement shall be made.</p>

## ELECTRICAL

TEST ITEM	SPECIFICATION	TEST DETAILS
Insulation resistance	There shall be no other damage or problems.	DC 100V voltage shall be applied across this sample of top surface and the terminal. The insulation resistance shall be more than $1 \times 10^8 \Omega$ .
Dielectric withstand voltage	There shall be no other damage or problems.	AC 100V voltage shall be applied for 1 minute across the top surface and the terminal of this sample
Temperature characteristics	$\Delta L/L20^\circ C \leq \pm 10\%$ 0 ~ 2000 ppm/°C	The test shall be performed after the sample has stabilized in an ambient temperature of -20 to +85°C, and the value calculated based on the value applicable in a normal temperature and normal humidity shall be $\Delta L/L20^\circ C \leq \pm 10\%$ .

## ENVIROMENT CHARACTERISTICS

TEST ITEM	SPECIFICATION																
High temperature storage	$\Delta L/Lo \leq \pm 5\%$  There shall be no mechanical damage.	The sample shall be left for $96 \pm 4$ hours in an atmosphere with a temperature of $85 \pm 2^\circ\text{C}$ and a normal humidity.  Upon completion of the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.															
Low temperature storage	$\Delta L/Lo \leq \pm 5\%$  There shall be no mechanical damage.	The sample shall be left for $96 \pm 4$ hours in an atmosphere with a temperature of $-25 \pm 3^\circ\text{C}$ .  Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity for 1 hour.															
Change of temperature	$\Delta L/Lo \leq \pm 5\%$  There shall be no other damage of problems	The sample shall be subject to 5 continuous cycles, such as shown in the table 2 below and then it shall be subjected to standard atmospheric conditions for 1 hour, after which measurement shall be made.  <div style="text-align: center;">                         table 2  <table border="1" style="margin-left: auto; margin-right: auto;"> <thead> <tr> <th></th> <th style="text-align: center;">Temperature</th> <th style="text-align: center;">Duration</th> </tr> </thead> <tbody> <tr> <td style="text-align: center;">1</td> <td style="text-align: center;"><math>-25 \pm 3^\circ\text{C}</math> (Thermostat No.1)</td> <td style="text-align: center;">30 min.</td> </tr> <tr> <td style="text-align: center;">2</td> <td style="text-align: center;">Standard atmospheric</td> <td style="text-align: center;">No.1→No.2</td> </tr> <tr> <td style="text-align: center;">3</td> <td style="text-align: center;"><math>85 \pm 2^\circ\text{C}</math> (Thermostat No.2)</td> <td style="text-align: center;">30 min.</td> </tr> <tr> <td style="text-align: center;">4</td> <td style="text-align: center;">Standard atmospheric</td> <td style="text-align: center;">No.2→No.1</td> </tr> </tbody> </table> </div>		Temperature	Duration	1	$-25 \pm 3^\circ\text{C}$ (Thermostat No.1)	30 min.	2	Standard atmospheric	No.1→No.2	3	$85 \pm 2^\circ\text{C}$ (Thermostat No.2)	30 min.	4	Standard atmospheric	No.2→No.1
	Temperature	Duration															
1	$-25 \pm 3^\circ\text{C}$ (Thermostat No.1)	30 min.															
2	Standard atmospheric	No.1→No.2															
3	$85 \pm 2^\circ\text{C}$ (Thermostat No.2)	30 min.															
4	Standard atmospheric	No.2→No.1															
Moisture storage	$\Delta L/Lo \leq \pm 5\%$  There shall be no mechanical damage.	The sample shall be left for $96 \pm 4$ hours in a temperature of $40 \pm 2^\circ\text{C}$ and a humidity(RH) of 90~95%.  Upon completion of the test, the measurement shall be made after the sample has been left in a normal temperature and normal humidity more than 1 hour.															
Test conditions :  The sample shall be reflow soldered onto the printed circuit board in every test.																	

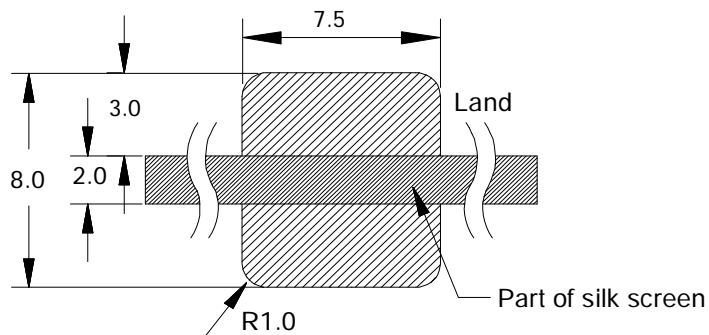
## (5) LAND DIMENSION (Ref.)

PCB: GLASS EPOXY  $t=1.6\text{mm}$

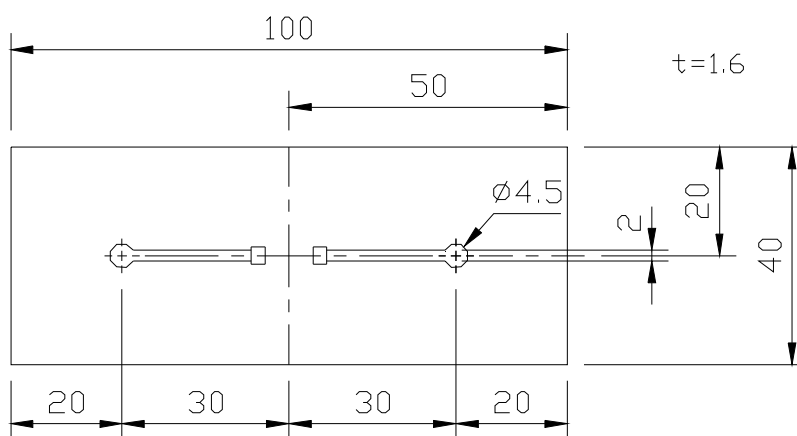
### (5)-1 LAND PATTERN DIMENSIONS

(STANDARD PATTERN)

Unit:mm

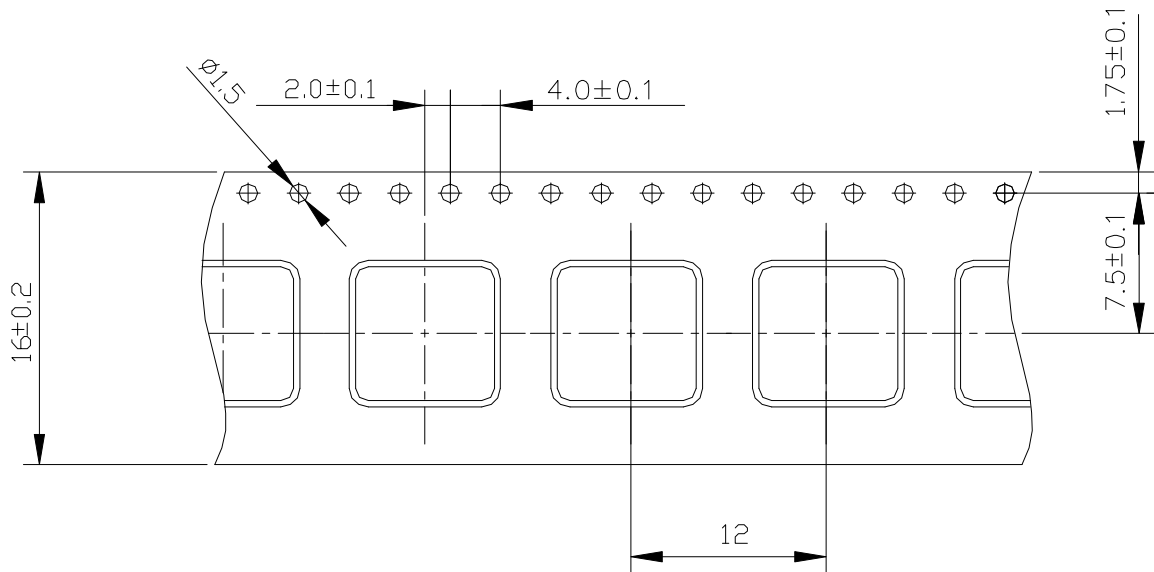


### (5)-2 SUBSTRATE BENDING TEST BENDING TEST BOARD

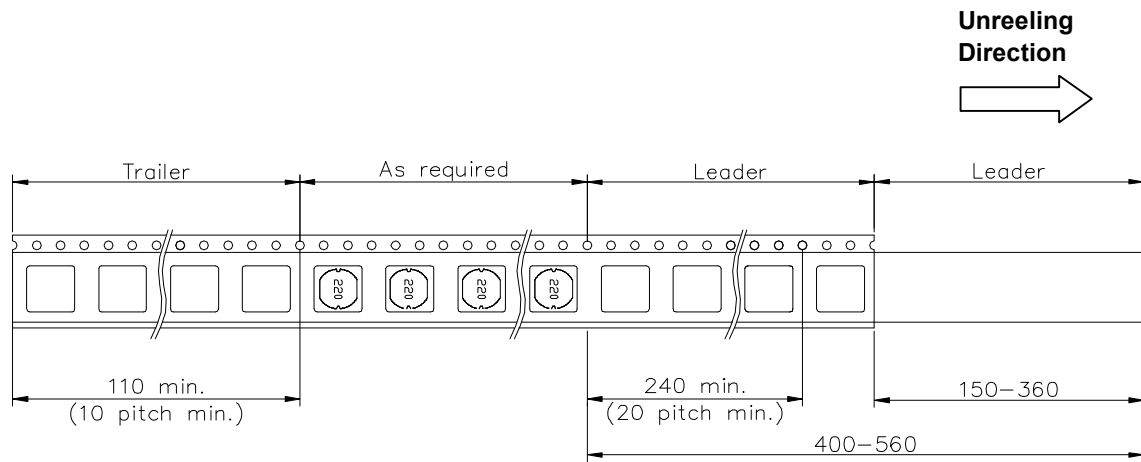


## (6) PACKAGING

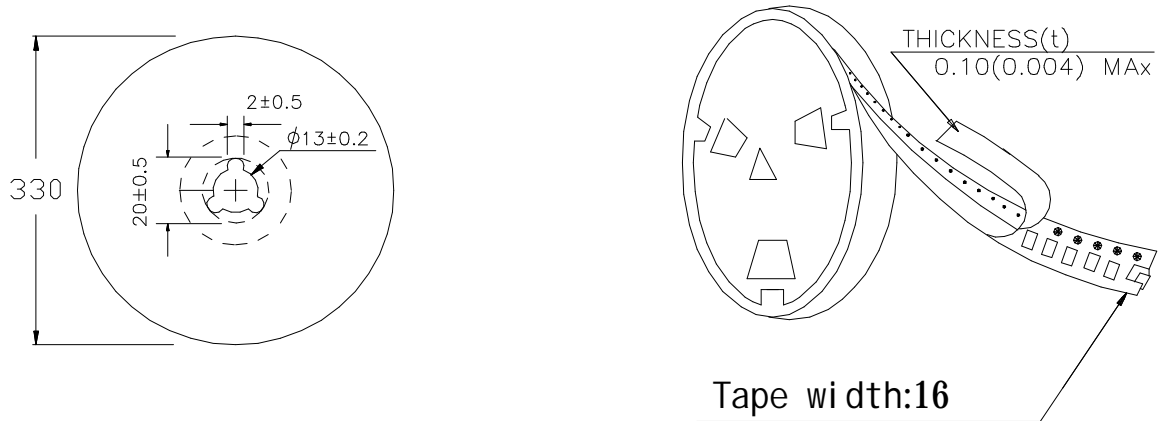
### (6)-1 CARRIER TAPE DIMENSIONS (mm)



### (6)-2 TAPING DIMENSIONS (mm)



### (6)-3 REEL DIMENSIONS (mm)



### (6)-4 QUANTITY

1000 pcs/Reel

The products are packaged so that no damage will be sustained.